

Adapts PCIe XMC to PXI Express with P16 High Speed Communications Ports and Digital IO

V2.01

#### **FEATURES**

- Adapt one XMC PCI Express VITA 42.3 module to a PXI Express slot
- · Supports up to 8 lanes, PCle gen3
- Transparent Operation
- Eight high-speed gigabit transceiver (GTH) lanes from XMC P16 exposed via dual, frontpanel QSFP connectors and 8 differential DIO pairs routed from P16 to a high-speed, frontpanel Samtec connector.

OR:

Eight high-speed gigabit transceiver (GTH) lanes from XMC P16 exposed via dual, front-panel MINI SAS HD connectors and 16 differential DIO pairs routed from P16 to a high-speed, front-panel Samtec connector.

- IEEE 1384 XMC mechanicals
- >50W power provided to the module
- · Robust end bracket
- · Dedicated fan provides 19 CFM air flow
- · Consumes two contiguous PXIe slots
- Supports newest Innovative XMC cards which provide 5 GHz analog I/O & use of the Kintex XCKU060/XCKU085 Ultrascale FPGA

### **APPLICATIONS**

- Add XMC modules to standard PXIe host systems
- System expansion using high speed serial links

### **SOFTWARE**

· No software required



#### **DESCRIPTION**

The PXI Express to XMC module adapter allows a standard 75 x 150mm PCIe XMC module to be used in a PXI Express slot. The XMC module must be VITA 42.3-compatible and may support up to eight PCI Express lanes. The adapter is completely transparent to PCI Express. All PCIe bus signals from the PXI Express host bus are connected directly to the XMC module (the PCIe clock is rebiased). The PXIe adapter can be utilized with Innovative XMC cards including our newest generation models which provide 5 GHz analog I/O and use the Kintex XCKU060/XCKU085 Ultrascale FPGA.

Two front panel configurations are available for XMC GTH transceivers and general purpose DIO:

QSFP option: Eight GTH transceivers from the XMC P16 connector are routed to two front-panel QSFP connectors to provide inter-FPGA communications at 10 GB/s. The connectors provide a simple way to "patch-panel" communications links between cards. Six DIO lines are routed from the XMC P16 connector to each QSFP control interface, and eight differential DIO pairs are routed to a separate high speed Samtec connector.

MINI SAS HD option: Eight GTH transceivers from the XMC P16 connector are routed to two front-panel MINI SAS HD connectors to provide inter-FPGA communications at 10 GB/s. The connectors provide a simple way to "patch-panel" communications links between cards. Sixteen differential DIO

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pairs are routed to a separate high speed Samtec connector.

Special support for trigger and timing inputs to Innovative XMC modules is provided through their front-panel SMA/SMMC connectors or PXIe backplane differential signals.

Convection cooling via a dedicated fan, provides cooling to the XMC module.

The XMC module mounts securely to the adapter using standoffs and with the end bracket. The bracket mates to standard PMC end brackets and supports an EMI gasket.



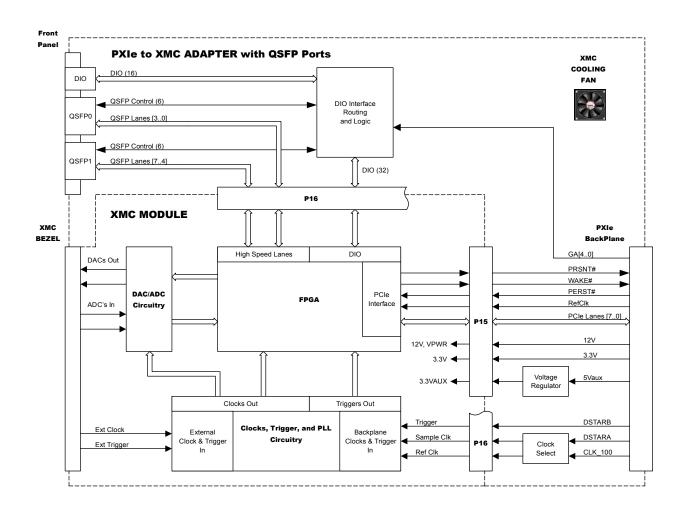
This electronics assembly can be damaged by ESD. Innovative Integration recommends that all electronic assemblies and components circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

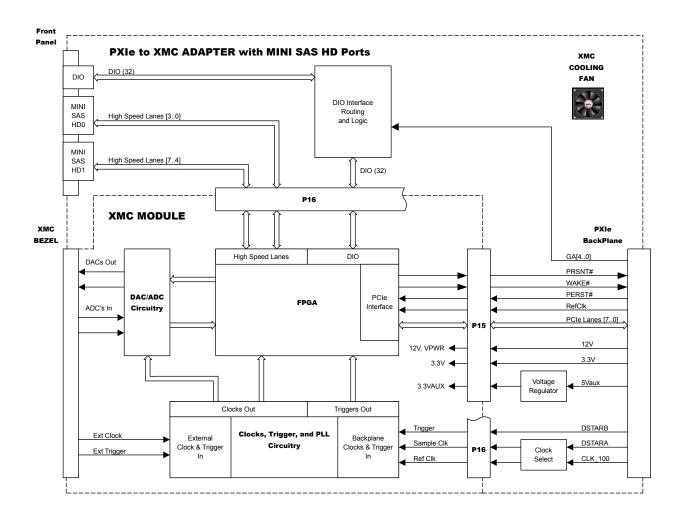
### **ORDERING INFORMATION**

Product	Part Number	Description
PXIe-XMC Adapter with I/O expansion for X6 modules (QSFP Ports)	80341-1	PXIe XMC x8 Lane Adapter for Innovative X6, XA and XU-series XMC modules, 3U 8HP (Fan unit w/QSFP, QSFP Control, and 8 differential DIO pairs)
PXIe-XMC Adapter with I/O expansion for X3 modules	80341-2	PXIe XMC x8 Lane Adapter for Innovative X3-series XMC modules, 3U 8HP (Fan unit and 8 differential DIO pairs)
PXIe-XMC Adapter with I/O expansion for X6 modules (MINI SAS HD Ports)	80341-5	PXIe XMC x8 Lane Adapter for Innovative X6, XA and XU-series XMC modules, 3U 8HP (Fan unit w/MINI SAS HD, and 16 differential DIO pairs)

## **Adapter Block Diagram with QSFP Ports (with Typical XMC Module)**



## Adapter Block Diagram with MINI SAS HD Ports (with Typical XMC Module)



Physicals		
Form Factor	PXI Express 3U, dual-slot	
Size	3.72 in x 8.05 in	
Weight	100g	

Power Capability Delivered to the XMC (from backplane)		
Volts	Amps	
3.3V	6A Maximum	
5VAUX (makes XMC 3.3VAUX)	1A Maximum, to XMC 3.3VAUX	
+12V 4A Maximum, to +12V & VPWR		
-12V	Not provided to XMC	

<sup>\*\*</sup> XMC cooling may be required

### **DIO Signal Mapping for**

### X6, XA, XU families

XMC	X6	J3 DIO PORT	X6	XMC
P16 C1	DGND 3	3 4	DGND DIO P4	P16 C5
C2 F1	DIO_N0 5 DGND 7 DIO_P1 9	7 8	6 DIO_N4 8 DGND 10 DIO P5	C6 F5
F2	DIO N1 11	11 12	12 DIO N5	F6
F4 F3	DIO NS 15 DIO P3 17	15 16	16 BIO N7 18 DIO P7	F8 F7
C4 C3	DGND 19 DIO N2 21 DIO_P2 23	19 20 21 22	22 DGND DIO N8 24 DIO_P6	C8 C7
	DGND 25	25 26	26 DGND ERF8-013-01-L-D-RA-L-TR	

### **QSFP DIO Configuration**

#### J3 - Front Panel Connector for XMC DIO

DIO Signals are routed as 8 differential pairs. Pairs are 50 ohm, 100 ohm differential characteristic impedance, suitable for LVDS or LVPECL. These signals can also be used as single ended LVCMOS or LVTTL according to the configuration of the XMC module.

Connector: Samtec ERF8-013-01-L-D-RA-L-TR

Mating cables:

Samtec ERCD-013 series or equivalent (coax ribbon type for single ended signals)

Samtec ERDP-013 series or equivalent (twinax ribbon type for differential signals)

### **DIO Signal Mapping for X3 family**

XMC P16	X3 DIO	J3 <u>DIO POR</u> T		X3 DIO	XMC P16	
C1 C2	DIO0 DIO1	DGND 3 DIO N0 5	1 2 3 4 5 6	2 DGND 4 DIO P4 6 DIO N4	DIO8 DIO9	C9 C10
C3 C4	DIO2 DIO3	DGND 9 DIO P1 9	7 8 9 10 11 12	8 DGND 10 DIO P5 12 DIO N5	DIO10 DIO11	C11 C12
C8 C7	DIO7 DIO6	DGND 13 DIO N3 15 DIO P3 17	13 14 15 16 17 18	14 DGND 16 DIO N7	DIO15 DIO14	C16 C15
C6 C5	DIO5 DIO4	DGND 21 DIO P2 23	19 20 21 22 23 24	20 DGND 22 DGND 24 DIO N6	DIO13 DIO12	C14 C13
		DGND 25	25 26	26 DGND ERF8-013-01-L-D-RA-L-TR		

### J1 & J2 Front Panel Connectors for QSFP0 & QSFP1

XMC High Speed Serial Pair	XMC P16 Pins (P/N)	QSFP Connectors (0 and 1)
TXP0/N0	A1/B1	0: TXP0/N0
TXP1/N1	D1/E1	0: TXP1/N1
TXP2/N2	A3/B3	0: TXP2/N2
TXP3/N3	D3/E3	0: TXP3/N3
TXP4/N4	A5/B5	1: TXP0/N0
TXP5/N5	D5/E5	1: TXP1/N1
TXP6/N6	A7/B7	1: TXP2/N2
TXP7/N7	D7/E7	1: TXP3/N3
RXP0/N0	A11/B11	0: RXP0/N0
RXP1/N1	D11/E11	0: RXP1/N1
RXP2/N2	A13/B13	0: RXP2/N2
RXP3/N3	D13/E13	0: RXP3/N3
RXP4/N4	A15/B15	1: RXP0/N0
RXP5/N5	D15/E15	1: RXP1/N1
RXP6/N6	A17/B17	1: RXP2/N2
RXP7/N7	D17/E17	1: RXP3/N3

Connector: TE Connectivity 1761987-9

Housing: TE\_Connectivity 1888781-1

Mating Cable: (Standard QSFP Cable)

### **MINI SAS HD DIO Configuration**

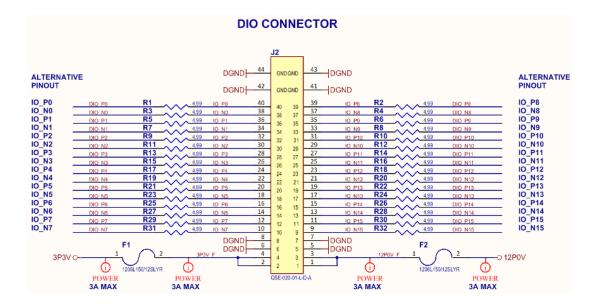
#### J2 - Front Panel Connector for XMC DIO

DIO Signals are routed as 16 differential pairs. Pairs are 50 ohm, 100 ohm differential characteristic impedance, suitable for LVDS or LVPECL. These signals can also be used as single ended LVCMOS or LVTTL according to the configuration of the XMC module.

Connector: Samtec QSE-020-01-L-D-A

Mating cable:

Samtec EQCD-020 series or equivalent (coax ribbon type for single ended signals)



### J1 Front Panel Connector for MINI SAS HD Ports 0 & 1

XMC High Speed Serial Pair	XMC P16 Pins (P/N)	MINI SAS HD Connector (Ports 0 and 1)
TXP0/N0	A1/B1	0: TXP0/N0
TXP1/N1	D1/E1	0: TXP1/N1
TXP2/N2	A3/B3	0: TXP2/N2
TXP3/N3	D3/E3	0: TXP3/N3
TXP4/N4	A5/B5	1: TXP0/N0
TXP5/N5	D5/E5	1: TXP1/N1
TXP6/N6	A7/B7	1: TXP2/N2
TXP7/N7	D7/E7	1: TXP3/N3
RXP0/N0	A11/B11	0: RXP0/N0
RXP1/N1	D11/E11	0: RXP1/N1
RXP2/N2	A13/B13	0: RXP2/N2
RXP3/N3	D13/E13	0: RXP3/N3
RXP4/N4	A15/B15	1: RXP0/N0
RXP5/N5	D15/E15	1: RXP1/N1
RXP6/N6	A17/B17	1: RXP2/N2
RXP7/N7	D17/E17	1: RXP3/N3

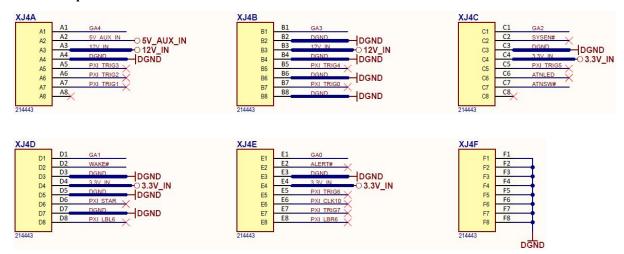
Connector: Amphenol G40H12331HR

Mating Cable: 3M 8US4-AA119 series

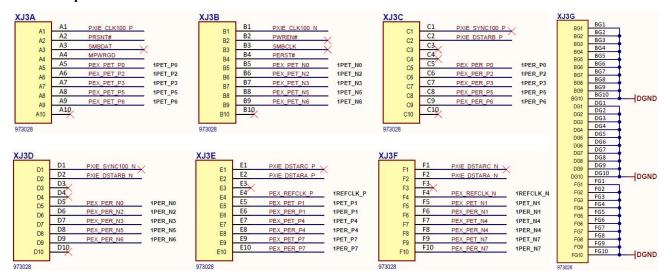
or 3M 8US4-CB119 series

or equivalent

### XJ4 - Backplane Connector



### XJ3 - Backplane Connector



#### XJ4 and XJ3 signal usage notes

Routed directly to corresponding XMC P15/P16 signals: PEX\_PET, PEX\_PER, PEX\_REFCLK, PERST# (PCI Express); WAKE#; PRSNT#; and PXIe DSTARB (trigger)

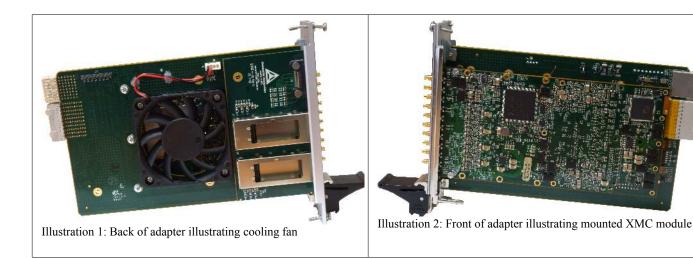
Available for XMC sample clock or PLL reference: PXIE CLK100 and PXIE DSTARA

### XJ4 and XJ3 signal usage notes (cont'd)

Not Used: PXI\_TRIGn, PXI\_STAR, PXI\_CLK10 (triggers with 10MHz resolution); SYSEN#; ALERT#; ATNLED; PXI\_LBL6; PXI\_LBR6; SMBDAT; SMBCLK; PWREN#; PXIE\_SYNC100; and PXIE\_STARC

Pulled up to 3.3V: ATNSW# (always idle); and MPWRGD (always good)

Routed to DIO inputs of XMC: GA[4..0] (slot ID information)



### **Applications Information**

### **High Speed Serial Communications**

The adapter card has 8 high speed serial lanes from the XMC card via P16 supporting Gigabit serial ports for intercard communications or expansion. The serial lanes connect directly to QSFP connectors (or MINI SAS HD connectors). Standard QSFP cables (MINI SAS HD cables) can be used to connect multiple cards together to create high speed, dedicated communications channels between XMC modules. On Innovative's XA, X6 and XU modules, these are multi-gigabit ports directly from the XMC Virtex FPGA.

### **Digital IO**

Digital IO from XMC P16 is directly mapped to the Samtec connector on the adapter front panel. There are 8 differential pairs (100 ohm) with matched length for the QSFP version, 16 differential pairs (100 ohm) with matched length for the MINI SAS HD version. Mating cables suitable for high-speed differential pairs are available.

#### **Cooling the XMC Module**

Many XMC modules require special considerations to provide adequate cooling. Monitor XMC module device temperatures and add convective air flow if required to maintain within rated thermal limits.

The module provides a conduction cooling path for XMC modules employing a VITA20-compliant heat spreader and dedicated thermal plane. The conduction cooling conforms to VITA20 specification for PMC/XMC module cooling. When a compatible module/spreader is used with the card, the adapter thermal plane effectively conducts heat from the module to the carrier card and front bracket. System cooling is therefore more effective because of the heat spreading from the module to the carrier card. However, this conductive path is insufficient for highly-dissipative XMC modules.

A fan is included on the PXIe-XMC adapter for cooling. The fan provides approximately 19 CFM air flow. When the fan is installed, it blows air directly on the module and is very effective. The fan protrudes 10mm from the back of the card and intrudes into the adjacent slot in the PXIe chassis. Hence, the adapter and fan are said to consume two PXIe slots.

#### **Module Mounting Hardware**

The module can be securely mounted to the adapter for both conduction cooling and ruggedness. Two 10mm female threaded standoffs are used to secure the module to the adapter. If conduction cooling is used, cooling bars are secured to the card and the module using 2.5 mm screws. This hardware can be purchased from Innovative Integration.

### **Software Driver**

No software is required.

### **Switch Settings**

### SW1 – Sample Clock Settings (for the clock supplied to P16 of the XMC Module)

Switch Number	Function	Settings	
1	Clock Source Select (from PXIe Backplane)	On = PXIE_CLK100 Off = PXIE_DSTARA	
2	Sample Clock Enable Always On except when switch #3 is On	On = Supply clock to XMC P16-A9, B9 Off = Do not supply clock to P16-A9, B9	
3	Reference Clock Enable On only when using the PLL of an X3 family XMC Module	On = Supply clock to XMC P16-D9, E9 Off = Do not supply clock on P16-D9, E9	
4	Signal Type (to XMC Module) Always On, because all Innovative Integration XMC Modules use LVDS	On = Clock signal is LVDS Off = Clock signal is LVPECL	

If an XMC Module from another manufacturer is used, recommendations in the "Function" column may not apply, and settings should be made according to the information in the "Settings" column.

### SW2 - Fan Speed Control (Not Applicable to Adapter -0 version)

Fan Speed Control is not currently implemented; the fan always runs at full speed. Therefore the settings of SW2 are "Don't Care". Contact the factory if fan speed control is required.

Note: Adapter -0 version does not have a fan.

### SW3 - VCCIO Voltage Selection and routing for Geographic Address (Adapter -0 version only)

Switch Number	Function	Settings
1	VCCIO Voltage Selection	1.5V = 1 & 2  Off
2	1.8V: for XU family 2.5V: for X6, X3, X5, & XA families	1.8V = 1  On;  2  Off 2.5V = 1 & 2  On
3	Geographic Address routing	X5 (except X5-COM) = 3 Off, 4 On
4		All Other families = 3 On, 4 Off

This switch applies only to Adapter -0 versions because the other Adapter versions have a mezzanine assembly matched to the installed XMC that accounts for these Voltage Selection and Geographic routing requirements.

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